Zener Voltage Regulators

225 mW SOT-23 Surface Mount

This series of Zener diodes is offered in the convenient, surface mount plastic SOT–23 package. These devices are designed to provide voltage regulation with minimum space requirement. They are well suited for applications such as cellular phones, hand held portables, and high density PC boards.

Features

- Pb-Free Packages are Available
- 225 mW Rating on FR-4 or FR-5 Board
- Zener Breakdown Voltage Range 2.4 V to 75 V
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications
- ESD Rating of Class 3 (>16 KV) per Human Body Model
- Tight Tolerance Series Available (See Page 4)

Mechanical Characteristics

CASE: Void-free, transfer-molded, thermosetting plastic case

FINISH: Corrosion resistant finish, easily Solderable

MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

260°C for 10 Seconds

POLARITY: Cathode indicated by polarity band

FLAMMABILITY RATING: UL 94 V-0

MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Total Power Dissipation on FR-5 Board, (Note 1) @ T _A = 25°C Derated above 25°C Thermal Resistance, Junction-to-Ambient	P_D	225 1.8 556	mW mW/°C °C/W
Total Power Dissipation on Alumina Substrate, (Note 2) @ T _A = 25°C Derated above 25°C Thermal Resistance, Junction–to–Ambient	P_D	300 2.4 417	mW mW/°C °C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C

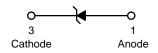
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- 1. $FR-5 = 1.0 \times 0.75 \times 0.62 \text{ in.}$
- 2. Alumina = 0.4 X 0.3 X 0.024 in., 99.5% alumina.



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SOT-23 CASE 318 STYLE 8

MARKING DIAGRAM



xxx = Specific Device Code M = Month Code

ORDERING INFORMATION

Device*	Package	Shipping [†]
BZX84CxxxLT1	SOT-23	3000/Tape & Reel
BZX84CxxxLT1G	SOT-23 (Pb-Free)	3000/Tape & Reel
BZX84CxxxLT3	SOT-23	10,000/Tape & Reel
BZX84BxxxLT1	SOT-23	3000/Tape & Reel
BZX84BxxxLT1G	SOT-23 (Pb-Free)	3000/Tape & Reel
BZX84BxxxLT3	SOT-23	10,000/Tape & Reel

- *The "T1" suffix refers to an 8 mm, 7 inch reel. The "T3" suffix refers to an 8 mm, 13 inch reel.
- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

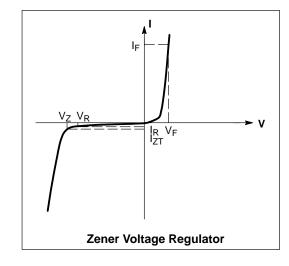
DEVICE MARKING INFORMATION

See specific marking information in the device marking column of the Electrical Characteristics table on page 3 of this data sheet.

ELECTRICAL CHARACTERISTICS

(Pinout: 1-Anode, 2-No Connection, 3-Cathode) (T_A = 25°C unless otherwise noted, V_F = 0.95 V Max. @ I_F = 10 mA)

Symbol	Parameter
VZ	Reverse Zener Voltage @ I _{ZT}
I _{ZT}	Reverse Current
Z _{ZT}	Maximum Zener Impedance @ I _{ZT}
I _R	Reverse Leakage Current @ V _R
V _R	Reverse Voltage
I _F	Forward Current
V _F	Forward Voltage @ I _F
ΘV _Z	Maximum Temperature Coefficient of V _Z
С	Max. Capacitance @ V _R = 0 and f = 1 MHz



ELECTRICAL CHARACTERISTICS - BZX84CxxxLT1 SERIES (STANDARD TOLERANCE)

(Pinout: 1-Anode, 2-No Connection, 3-Cathode) ($T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 0.90 \text{ V Max}$. @ $I_F = 10 \text{ mA}$) (Devices listed in **bold, italic** are ON Semiconductor Preferred devices.)

			/ _{Z1} (Volts I _{ZT1} = 5 r (Note 3)		Z _{ZT1} (Ω)	V _{Z2} @ I _{ZT2} (Not	= 1 mA	Z _{ZT2} (Ω)	V _{Z3} @ I _{ZT3} = (Not	= 20 mA	20 mA Leakage		Leakage		θ _{VZ} mV/k) _{T1} = 5 mA C (pF)	
Device	Device Marking	Min	Nom	Max	@ l _{ZT1} = 5 mA	Min	Max	@ l _{ZT2} = 1 mA	Min	Max	@ l _{ZT3} = 20 mA	I _R μΑ @	V _R Volts	Min	Max	@ V _R = 0 f = 1 MHz
BZX84C2V4LT1, G*	Z11	2.2	2.4	2.6	100	1.7	2.1	600	2.6	3.2	50	50	1	-3.5	0	450
BZX84C2V7LT1, G*	Z12	2.5	2.7	2.9	100	1.9	2.4	600	3	3.6	50	20	1	-3.5	0	450
BZX84C3V0LT1	Z13	2.8	3	3.2	95	2.1	2.7	600	3.3	3.9	50	10	1	-3.5	0	450
BZX84C3V3LT1, G*	Z14	3.1	3.3	3.5	95	2.3	2.9	600	3.6	4.2	40	5	1	-3.5	0	450
BZX84C3V6LT1, G*	Z15	3.4	3.6	3.8	90	2.7	3.3	600	3.9	4.5	40	5	1	-3.5	0	450
BZX84C3V9LT1, G*	Z16	3.7	3.9	4.1	90	2.9	3.5	600	4.1	4.7	30	3	1	-3.5	-2.5	450
BZX84C4V3LT1, G*	W9	4	4.3	4.6	90	3.3	4	600	4.4	5.1	30	3	1	-3.5	0	450
BZX84C4V7LT1	Z1	4.4	4.7	5	80	3.7	4.7	500	4.5	5.4	15	3	2	-3.5	0.2	260
BZX84C5V1LT1	Z2	4.8	5.1	5.4	60	4.2	5.3	480	5	5.9	15	2	2	-2.7	1.2	225
BZX84C5V6LT1	Z3	5.2	5.6	6	40	4.8	6	400	5.2	6.3	10	1	2	-2.0	2.5	200
BZX84C6V2LT1	Z4	5.8	6.2	6.6	10	5.6	6.6	150	5.8	6.8	6	3	4	0.4	3.7	185
BZX84C6V8LT1	Z5	6.4	6.8	7.2	15	6.3	7.2	80	6.4	7.4	6	2	4	1.2	4.5	155
BZX84C7V5LT1	Z6	7	7.5	7.9	15	6.9	7.9	80	7	8	6	1	5	2.5	5.3	140
BZX84C8V2LT1	Z 7	7.7	8.2	8.7	15	7.6	8.7	80	7.7	8.8	6	0.7	5	3.2	6.2	135
BZX84C9V1LT1	Z8	8.5	9.1	9.6	15	8.4	9.6	100	8.5	9.7	8	0.5	6	3.8	7.0	130
BZX84C10LT1, G*	Z9	9.4	10	10.6	20	9.3	10.6	150	9.4	10.7	10	0.2	7	4.5	8.0	130
BZX84C11LT1, G*	Y1	10.4	11	11.6	20	10.2	11.6	150	10.4	11.8	10	0.1	8	5.4	9.0	130
BZX84C12LT1, G*	Y2	11.4	12	12.7	25	11.2	12.7	150	11.4	12.9	10	0.1	8	6.0	10.0	130
BZX84C13LT1, G*	Y3	12.4	13	14.1	30	12.3	14	170	12.5	14.2	15	0.1	8	7.0	11.0	120
BZX84C15LT1	Y4	14.3	15	15.8	30	13.7	15.5	200	13.9	15.7	20	0.05	10.5	9.2	13.0	110
BZX84C16LT1, G*	Y5	15.3	16	17.1	40	15.2	17	200	15.4	17.2	20	0.05	11.2	10.4	14.0	105
BZX84C18LT1	Y6	16.8	18	19.1	45	16.7	19	225	16.9	19.2	20	0.05	12.6	12.4	16.0	100
BZX84C20LT1, G*	Y7	18.8	20	21.2	55	18.7	21.1	225	18.9	21.4	20	0.05	14	14.4	18.0	85
BZX84C22LT1, G*	Y8	20.8	22	23.3	55	20.7	23.2	250	20.9	23.4	25	0.05	15.4	16.4	20.0	85
BZX84C24LT1	Y9	22.8	24	25.6	70	22.7	25.5	250	22.9	25.7	25	0.05	16.8	18.4	22.0	80
			/ _{Z1} Belov I _{ZT1} = 2 r		Z _{ZT1} Below	@ l _{ZT2}	V _{Z2} Below @ l _{ZT2} = 0.1 m A Z _{ZT2} @		V _{Z3} Below Z _{ZT2} @ l _{ZT3} = 10 mA				Max Reverse Leakage Current		θ _{VZ} (mV/k) Below @ I _{ZT1} = 2 mA	
Device	Device Marking	Min	Nom	Max	@ I _{ZT1} = 2 mA	Min	Max	@ I _{ZT4} = 0.5 mA	Min	Max	@ l _{ZT3} = 10 mA	I _R μΑ @	V _R (V)	Min	Max	C (pF) @ V _R = 0 f = 1 MHz
BZX84C27LT1, G*	Y10	25.1	27	28.9	80	25	28.9	300	25.2	29.3	45	0.05	18.9	21.4	25.3	70
BZX84C30LT1	Y11	28	30	32	80	27.8	32	300	28.1	32.4	50	0.05	21	24.4	29.4	70
BZX84C33LT1, G*	Y12	31	33	35	80	30.8	35	325	31.1	35.4	55	0.05	23.1	27.4	33.4	70
BZX84C36LT1	Y13	34	36	38	90	33.8	38	350	34.1	38.4	60	0.05	25.2	30.4	37.4	70
BZX84C39LT1, G*	Y14	37	39	41	130	36.7	41	350	37.1	41.5	70	0.05	27.3	33.4	41.2	45
BZX84C43LT1, G*	Y15	40	43	46	150	39.7	46	375	40.1	46.5	80	0.05	30.1	37.6	46.6	40
BZX84C47LT1, G*	Y16	44	47	50	170	43.7	50	375	44.1	50.5	90	0.05	32.9	42.0	51.8	40
BZX84C51LT1	Y17	48	51	54	180	47.6	54	400	48.1	54.6	100	0.05	35.7	46.6	57.2	40
BZX84C56LT1, G*	Y18	52	56	60	200	51.5	60	425	52.1	60.8	110	0.05	39.2	52.2	63.8	40
BZX84C62LT1	Y19	58	62	66	215	57.4	66	450	58.2	67	120	0.05	43.4	58.8	71.6	35
BZX84C68LT1, G*	Y20	64	68	72	240	63.4	72	475	64.2	73.2	130	0.05	47.6	65.6	79.8	35
BZX84C75LT1, G*	Y21	70	75	79	255	69.4	79	500	70.3	80.2	140	0.05	52.5	73.4	88.6	35

^{3.} Zener voltage is measured with a pulse test current I_Z at an ambient temperature of 25°C.

^{*} The "G" suffix indicates Pb-Free package available.

ELECTRICAL CHARACTERISTICS – BZX84BxxxL (Tight Tolerance Series) (Pinout: 1-Anode, 2-No Connection, 3-Cathode) ($T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 0.90$ V Max. @ $I_F = 10$ mA)

		V- (Vo	lts) @ l _{ZT}	- 5 mA	Z _{ZT} (Ω) @ I _{ZT} = 5 mA	Max Reverse Leakage Current			/z //k)		
	Device	V2 (VO	(Note 4)	- J IIIA	(Note 4)	I _R	I _R V _R μΑ Volts		= 5 mA	C (pF) @ V _R =0,	
Device	Marking	Min	Nom	Max	Max				Max	f = 1 MHz	
BZX84B4V7LT1	T10	4.61	4.7	4.79	80	3	2	-3.5	0.2	260	
BZX84B5V1LT1, G*	T11	5.00	5.1	5.20	60	2	2	-2.7	1.2	225	
BZX84B5V6LT1	T12	5.49	5.6	5.71	40	1	2	-2	2.5	200	
BZX84B6V2LT1, G*	T13	6.08	6.2	6.32	10	3	4	0.4	3.7	185	
BZX84B6V8LT1, G*	T14	6.66	6.8	6.94	15	2	4	1.2	4.5	155	
BZX84B7V5LT1, G*	T15	7.35	7.5	7.65	15	1	5	2.5	5.3	140	
BZX84B8V2LT1, G*	T16	8.04	8.2	8.36	15	0.7	5	3.2	6.2	135	
BZX84B9V1LT1, G*	T17	8.92	9.1	9.28	15	0.5	6	3.8	7	130	
BZX84B16LT1	T19	15.7	16	16.3	40	0.05	11.2	10.4	14	105	
BZX84B18LT1	T20	17.6	18	18.4	45	0.05	12.6	12.4	16	100	

^{4.} Zener voltage is measured with a pulse test current I_Z at an ambient temperature of 25°C.

^{*} The "G" suffix indicates Pb-Free package available.

TYPICAL CHARACTERISTICS

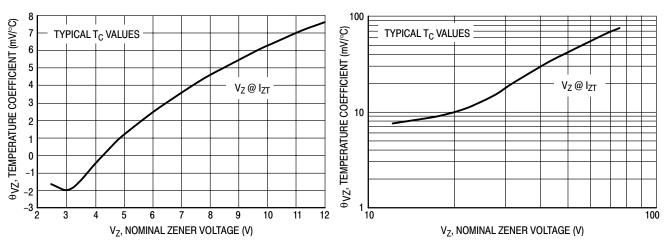


Figure 1. Temperature Coefficients (Temperature Range –55°C to +150°C)

Figure 2. Temperature Coefficients (Temperature Range -55°C to +150°C)

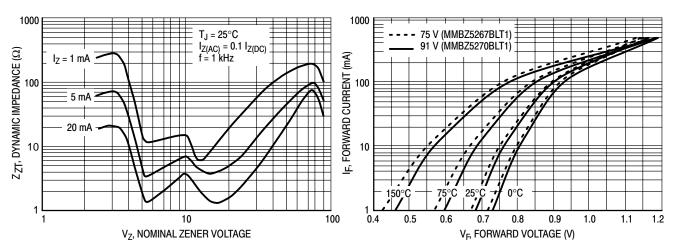


Figure 3. Effect of Zener Voltage on Zener Impedance

Figure 4. Typical Forward Voltage

TYPICAL CHARACTERISTICS

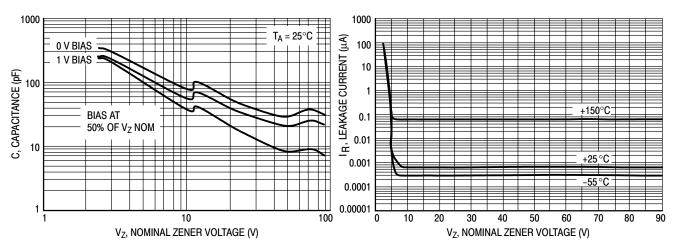


Figure 5. Typical Capacitance

Figure 6. Typical Leakage Current

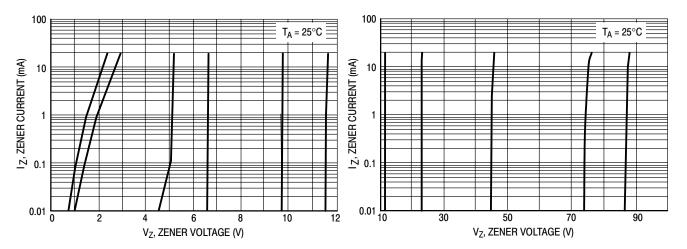
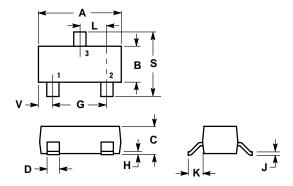


Figure 7. Zener Voltage versus Zener Current (V_Z Up to 12 V)

Figure 8. Zener Voltage versus Zener Current (12 V to 91 V)

PACKAGE DIMENSIONS

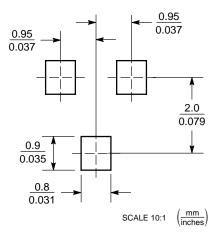
SOT-23 TO-236AB CASE 318-09 **ISSUE AK**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
 4. 318–01 THRU –07 AND –09 OBSOLETE, NEW STANDARD 318–08.

	INC	HES	MILLIM	IETERS		
DIM	MIN	MAX	MIN	MAX		
Α	0.1102	0.1197	2.80	3.04		
В	0.0472	0.0551	1.20	1.40		
С	0.0350	0.0440	0.89	1.11		
D	0.0150	0.0200	0.37	0.50		
G	0.0701	0.0807	1.78	2.04		
Н	0.0005	0.0040	0.013	0.100		
J	0.0034	0.0070	0.085	0.177		
K	0.0140	0.0285	0.35	0.69		
L	0.0350	0.0401	0.89	1.02		
S	0.0830	0.1039	2.10	2.64		
٧	0.0177	0.0236	0.45	0.60		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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